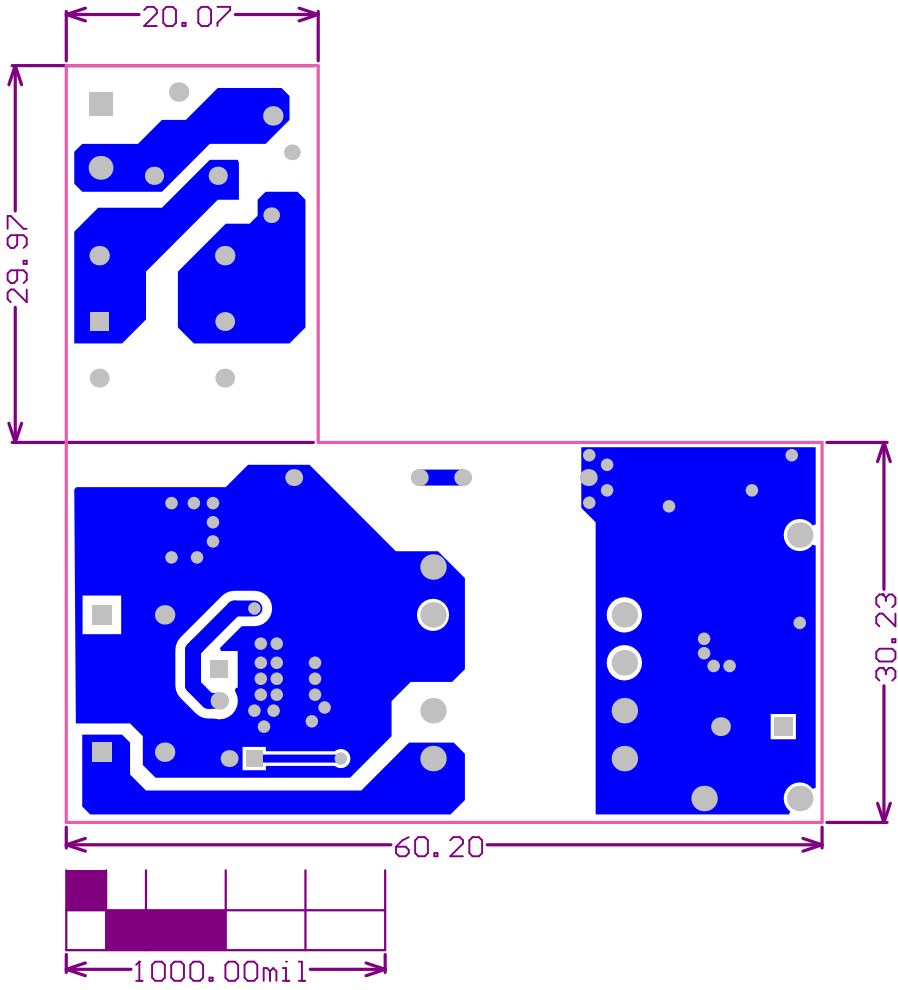


Top Layer M1 Board Outline M2 Board Dimensions Top Overlay

The reference design PMP30026 Rev-B has been built on PMP30026 Rev-A Board



Bottom Layer M1 Board Outline

M2 Board Dimensions

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